

SN54HC251, SN74HC251 DATA SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

SCLS132E – DECEMBER 1982 – REVISED SEPTEMBER 2003

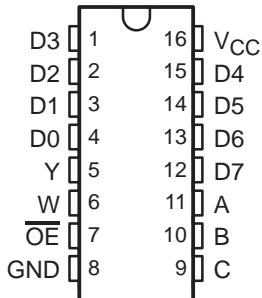
- 3-State Version of 'HC151
- Wide Operating Voltage Range of 2 V to 6 V
- High-Current 3-State Outputs Interface Directly With System Bus or Can Drive Up To 15 LSTTL Loads
- Low Power Consumption, 80- μ A Max I_{CC}
- Typical $t_{pd} = 9$ ns
- ± 6 -mA Output Drive at 5 V
- Low Input Current of 1 μ A Max
- Perform Parallel-to-Serial Conversion
- Complementary Outputs Provide True and Inverted Data

description/ordering information

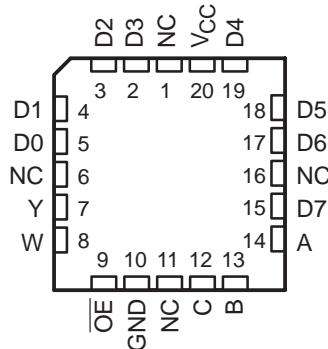
These data selectors/multiplexers contain full binary decoding to select 1-of-8 data sources and feature strobe-controlled complementary 3-state outputs.

The 3-state outputs can interface with and drive data lines of bus-organized systems. With all but one of the common outputs disabled (in the high-impedance state), the low impedance of the single enabled output drives the bus line to a high or low logic level. Both outputs are controlled by the output-enable (\overline{OE}) input. The outputs are disabled when \overline{OE} is high.

SN54HC251 . . . J OR W PACKAGE
SN74HC251 . . . D, DB, N, NS, OR PW PACKAGE
(TOP VIEW)



SN54HC251 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

ORDERING INFORMATION

TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	PDIP – N	Tube of 25	SN74HC251N	SN74HC251N
	SOIC – D	Tube of 40	SN74HC251D	HC251
		Reel of 2500	SN74HC251DR	
		Reel of 250	SN74HC251DT	
	SOP – NS	Reel of 2000	SN74HC251NSR	HC251
	SSOP – DB	Reel of 2000	SN74HC251DBR	HC251
	TSSOP – PW	Tube of 90	SN74HC251PW	HC251
		Reel of 2000	SN74HC251PWR	
		Reel of 250	SN74HC251PWT	
-55°C to 125°C	CDIP – J	Tube of 25	SNJ54HC251J	SNJ54HC251J
	CFP – W	Tube of 150	SNJ54HC251W	SNJ54HC251W
	LCCC – FK	Tube of 55	SNJ54HC251FK	SNJ54HC251FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

**SN54HC251, SN74HC251
DATA SELECTORS/MULTIPLEXERS
WITH 3-STATE OUTPUTS**

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FUNCTION TABLE

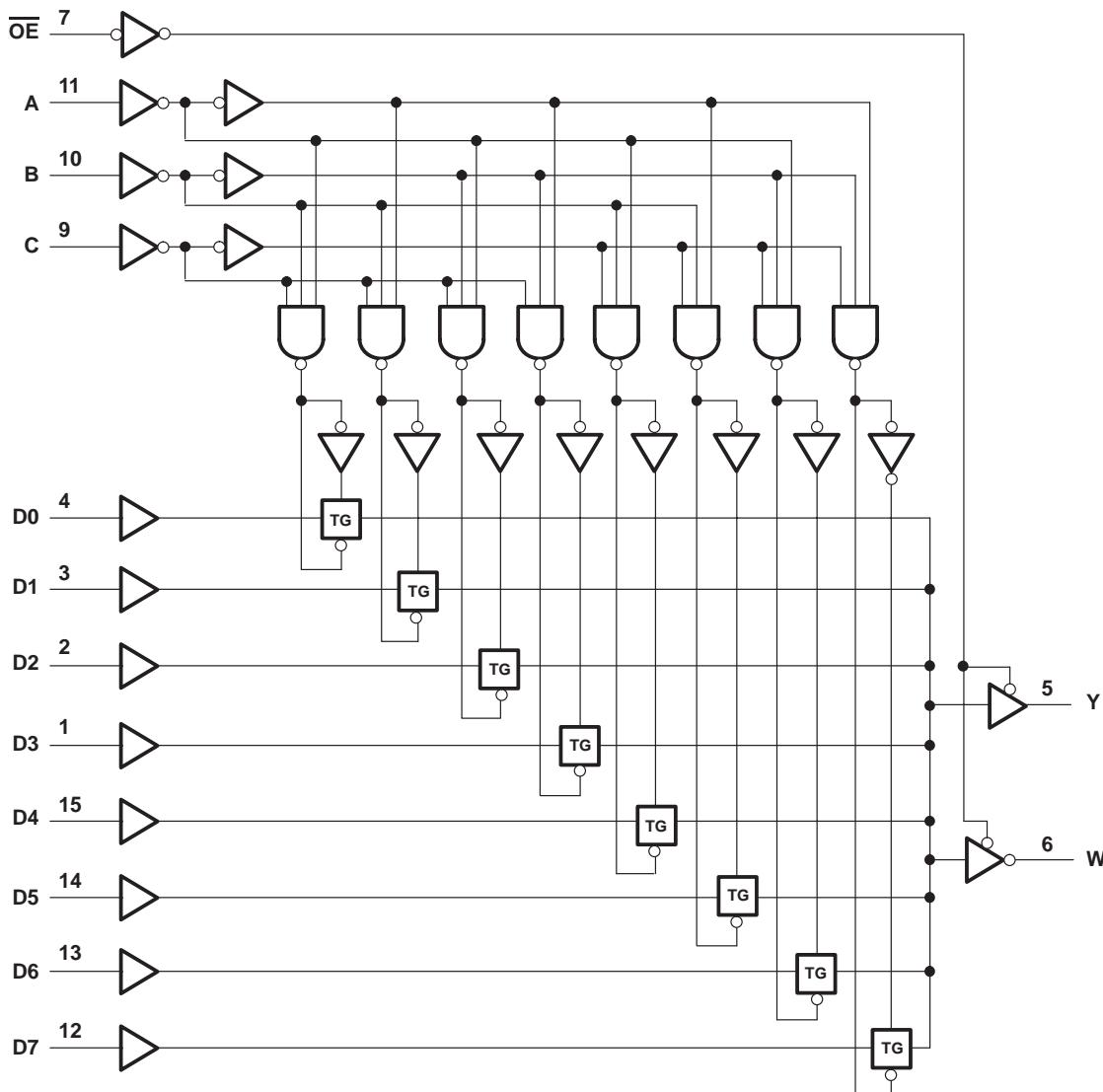
INPUTS			OUTPUTS		
SELECT			\overline{OE}		
C	B	A		Y	W
X	X	X	H	Z	Z
L	L	L	L	D0	$\overline{D0}$
L	L	H	L	D1	$\overline{D1}$
L	H	L	L	D2	$\overline{D2}$
L	H	H	L	D3	$\overline{D3}$
H	L	L	L	D4	$\overline{D4}$
H	L	H	L	D5	$\overline{D5}$
H	H	L	L	D6	$\overline{D6}$
H	H	H	L	D7	$\overline{D7}$

D0, D1 . . . D7 = the level of the respective D input



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logic diagram (positive logic)



Pin numbers shown are for the D, DB, J, N, NS, PW, and W packages.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V_{CC}	-0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1)	± 20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) (see Note 1)	± 20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	± 35 mA
Continuous current through V_{CC} or GND	± 70 mA
Package thermal impedance, θ_{JA} (see Note 2): D package	73°C/W
	DB package	82°C/W
	N package	67°C/W
	NS package	64°C/W
	PW package	108°C/W
Storage temperature range, T_{stg}	-65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JEDEC 51-7.

recommended operating conditions (see Note 3)

		SN54HC251			SN74HC251			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage	2	5	6	2	5	6	V
V _{IH}	High-level input voltage	V _{CC} = 2 V	1.5		1.5			V
		V _{CC} = 4.5 V	3.15		3.15			
		V _{CC} = 6 V	4.2		4.2			
V _{IL}	Low-level input voltage	V _{CC} = 2 V		0.5		0.5		V
		V _{CC} = 4.5 V		1.35		1.35		
		V _{CC} = 6 V		1.8		1.8		
V _I	Input voltage	0	V _{CC}	0	V _{CC}	0	V _{CC}	V
V _O	Output voltage	0	V _{CC}	0	V _{CC}	0	V _{CC}	V
Δt/Δv	Input transition rise/fall time	V _{CC} = 2 V		1000		1000		ns
		V _{CC} = 4.5 V		500		500		
		V _{CC} = 6 V		400		400		
T _A	Operating free-air temperature	-55	125	-40	85		°C	

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

SN54HC251, SN74HC251
DATA SELECTORS/MUXES
WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C			SN54HC251		SN74HC251		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V _{OH}	V _I = V _{IH} or V _{IL}	I _{OH} = -20 µA	2 V	1.9	1.998	1.9		1.9		V
			4.5 V	4.4	4.499	4.4		4.4		
			6 V	5.9	5.999	5.9		5.9		
		I _{OL} = -6 mA	4.5 V	3.98	4.3	3.7		3.84		
		I _{OL} = -7.8 mA	6 V	5.48	5.8	5.2		5.34		
V _{OL}	V _I = V _{IH} or V _{IL}	I _{OL} = 20 µA	2 V	0.002	0.1	0.1		0.1		V
			4.5 V	0.001	0.1	0.1		0.1		
			6 V	0.001	0.1	0.1		0.1		
		I _{OL} = 6 mA	4.5 V	0.17	0.26	0.4		0.33		
		I _{OL} = 7.8 mA	6 V	0.15	0.26	0.4		0.33		
I _I	V _I = V _{CC} or 0		6 V	±0.1	±100	±1000		±1000		nA
I _{OZ}	V _O = V _{CC} or 0, V _I = V _{IH} or V _{IL}		6 V	±0.01	±0.5	±10		±5		µA
I _{CC}	V _I = V _{CC} or 0, I _O = 0		6 V		8	160		80		µA
C _i		2 V to 6 V		3	10	10		10		pF

switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC}	T _A = 25°C			SN54HC251		SN74HC251		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{pd}	A, B, or C	W or Y	2 V	58	205		300		256		ns
			4.5 V	21	41		60		51		
			6 V	19	35		51		44		
	Any D	W or Y	2 V	44	195		283		244		
			4.5 V	17	39		57		49		
			6 V	15	33		48		41		
t _{en}	OE	W or Y	2 V	30	145		210		181		ns
			4.5 V	10	29		42		36		
			6 V	9	25		36		31		
t _{dis}	OE	W or Y	2 V	25	195		283		244		ns
			4.5 V	15	39		57		49		
			6 V	14	33		48		41		
t _t		W or Y	2 V	20	75		110		95		ns
			4.5 V	8	15		22		19		
			6 V	6	13		19		16		

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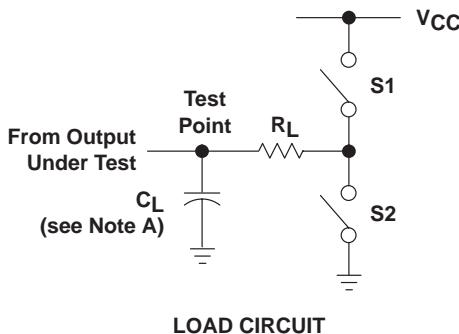
switching characteristics over recommended operating free-air temperature range, $C_L = 150 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC}	$T_A = 25^\circ\text{C}$			SN54HC251	SN74HC251	UNIT
				MIN	TYP	MAX	MIN	MAX	
t_{pd}	A, B, or C	W or Y	2 V	72	300	450	375	375	ns
			4.5 V	25	60	90	75	75	
			6 V	22	52	77	65	65	
	Any D	W or Y	2 V	59	300	450	375	375	
			4.5 V	21	60	90	75	75	
			6 V	18	52	77	65	65	
t_{on}	\overline{OE}	W or Y	2 V	50	230	340	285	285	ns
			4.5 V	17	46	68	57	57	
			6 V	15	40	58	50	50	
t_t		W or Y	2 V	45	210	315	265	265	ns
			4.5 V	17	42	63	53	53	
			6 V	13	36	53	45	45	

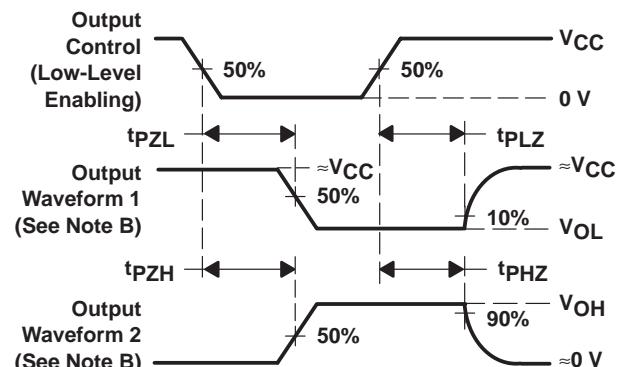
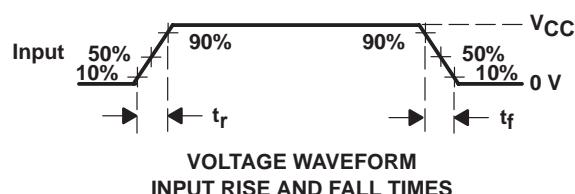
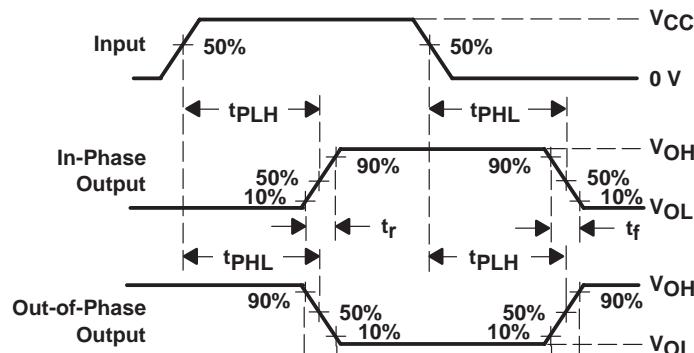
operating characteristics, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT
C_{pd} Power dissipation capacitance	No load	70	pF

PARAMETER MEASUREMENT INFORMATION



PARAMETER	R _L	C _L	S1	S2
t _{en}	1 kΩ	50 pF or 150 pF	Open	Closed
			Closed	Open
t _{dis}	1 kΩ	50 pF	Open	Closed
			Closed	Open
t _{pd} or t _t	--	50 pF or 150 pF	Open	Open



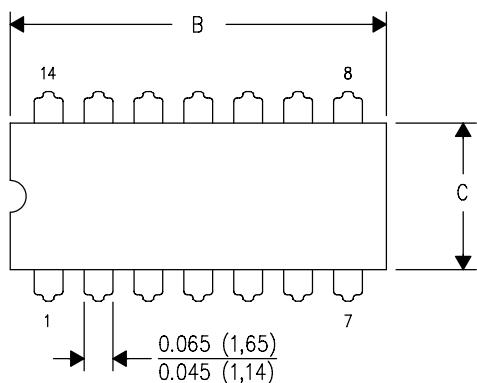
- NOTES:
- A. C_L includes probe and test-fixture capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z_O = 50 Ω, t_r = 6 ns, t_f = 6 ns.
 - D. The outputs are measured one at a time with one input transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
 - F. t_{PLZ} and t_{PZH} are the same as t_{en}.
 - G. t_{PLH} and t_{PHL} are the same as t_{pd}.

Figure 1. Load Circuit and Voltage Waveforms

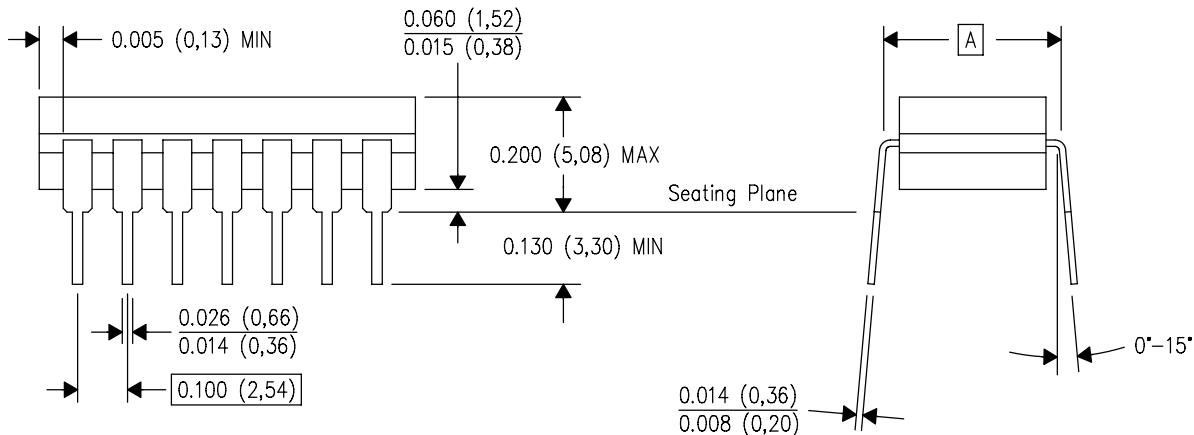
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS **\nDIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



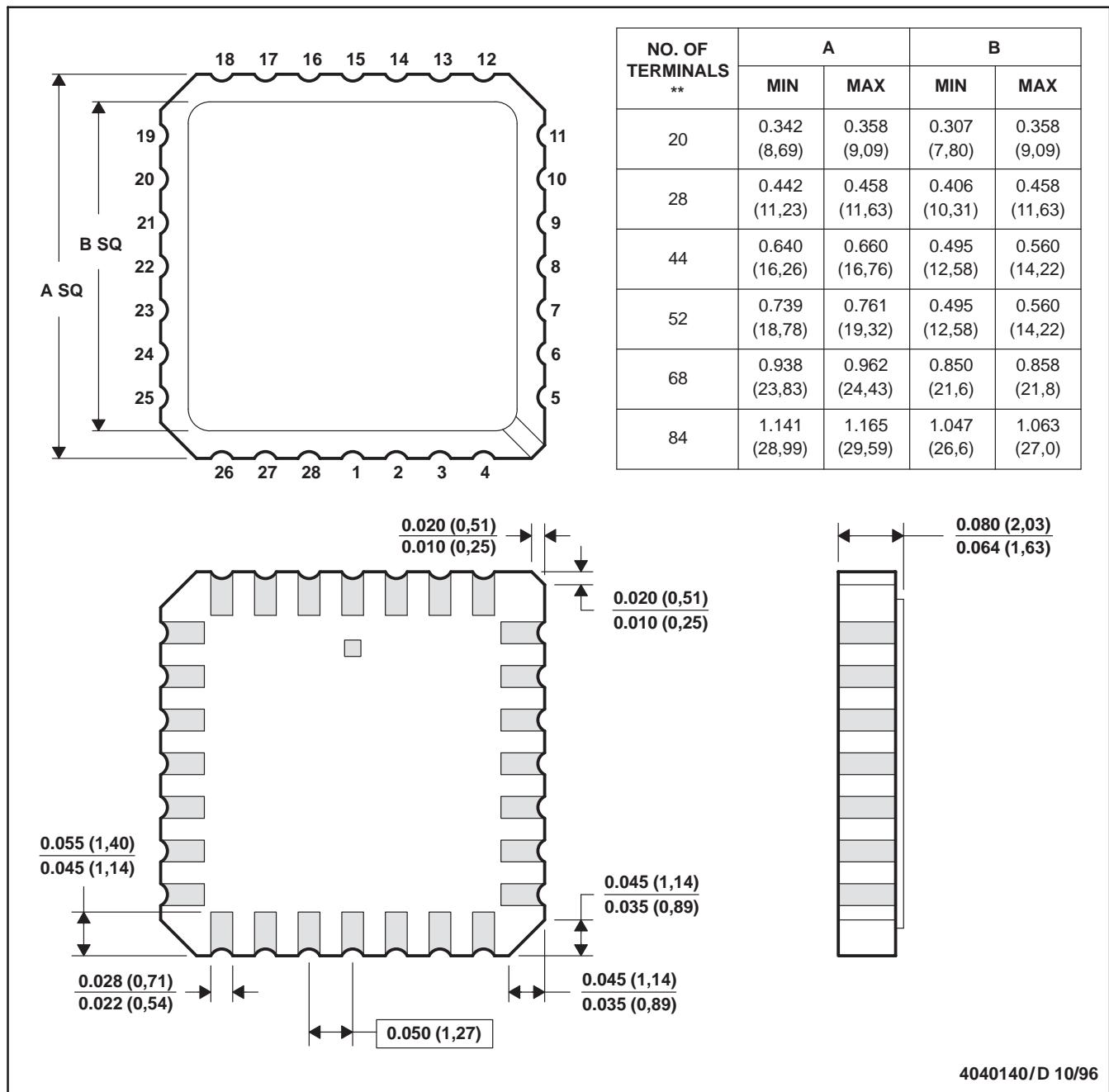
4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. This package can be hermetically sealed with a metal lid.

D. The terminals are gold plated.

E. Falls within JEDEC MS-004

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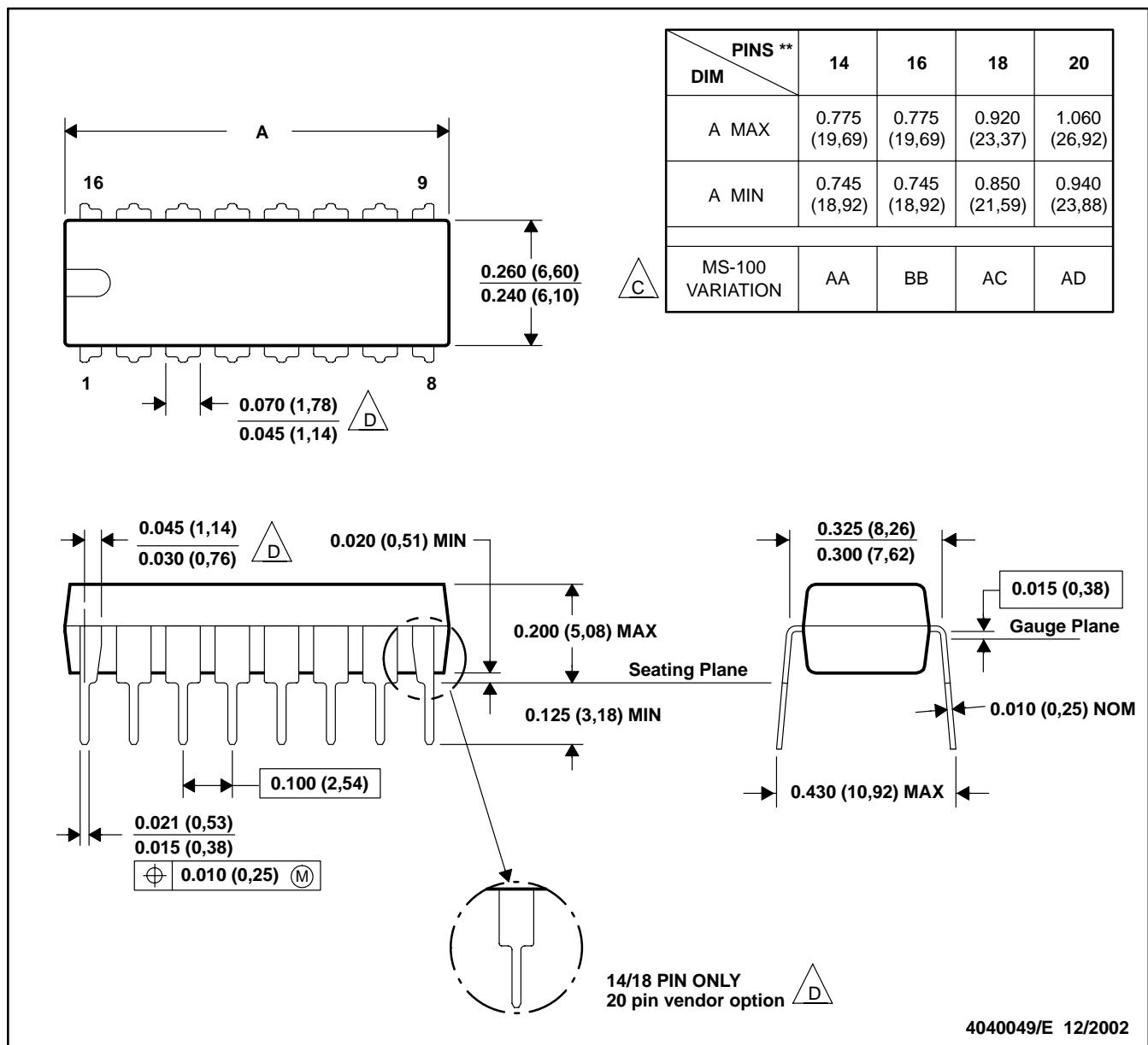
MECHANICAL

MPDI002C – JANUARY 1995 – REVISED DECEMBER 20002

N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

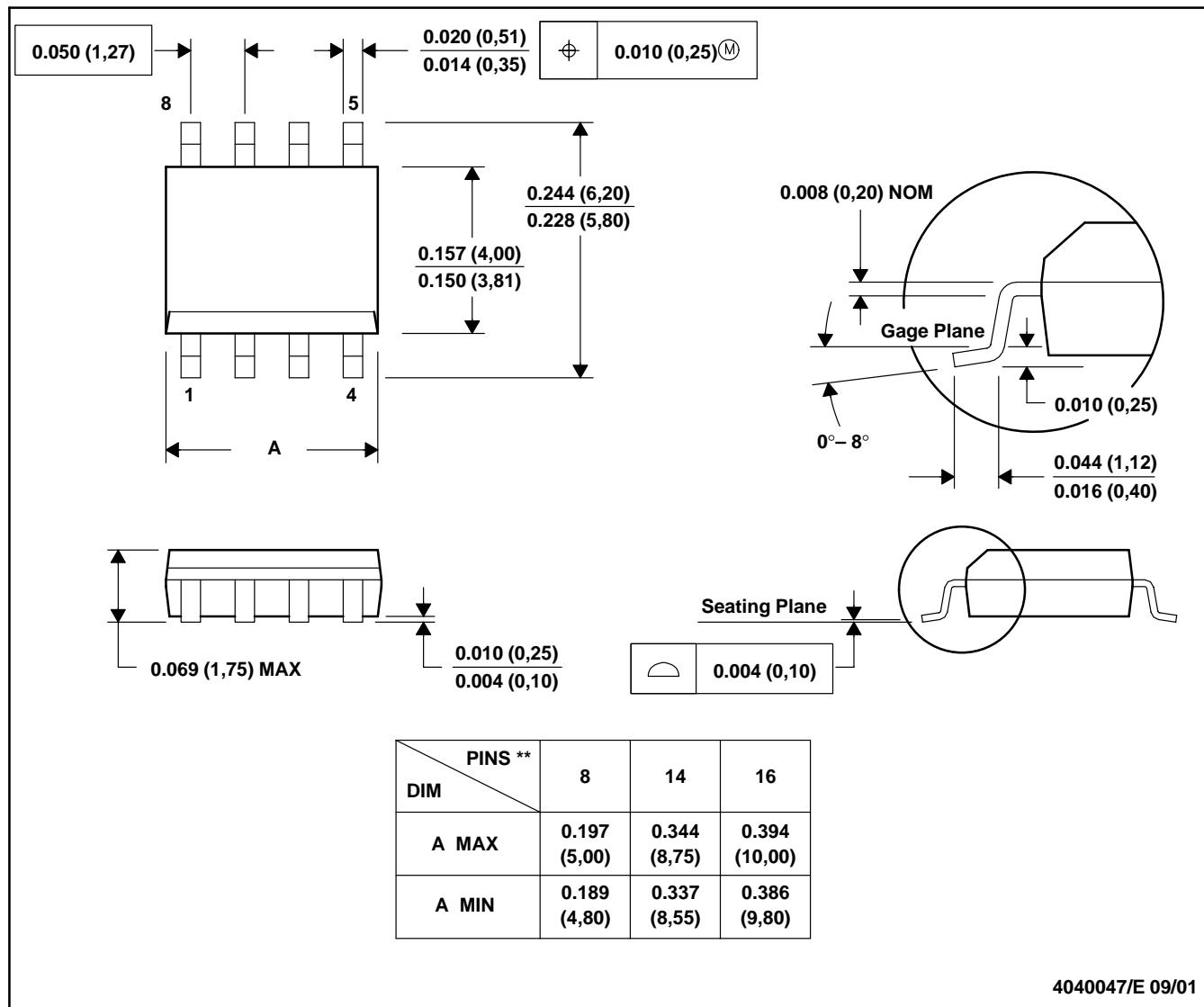
C. Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



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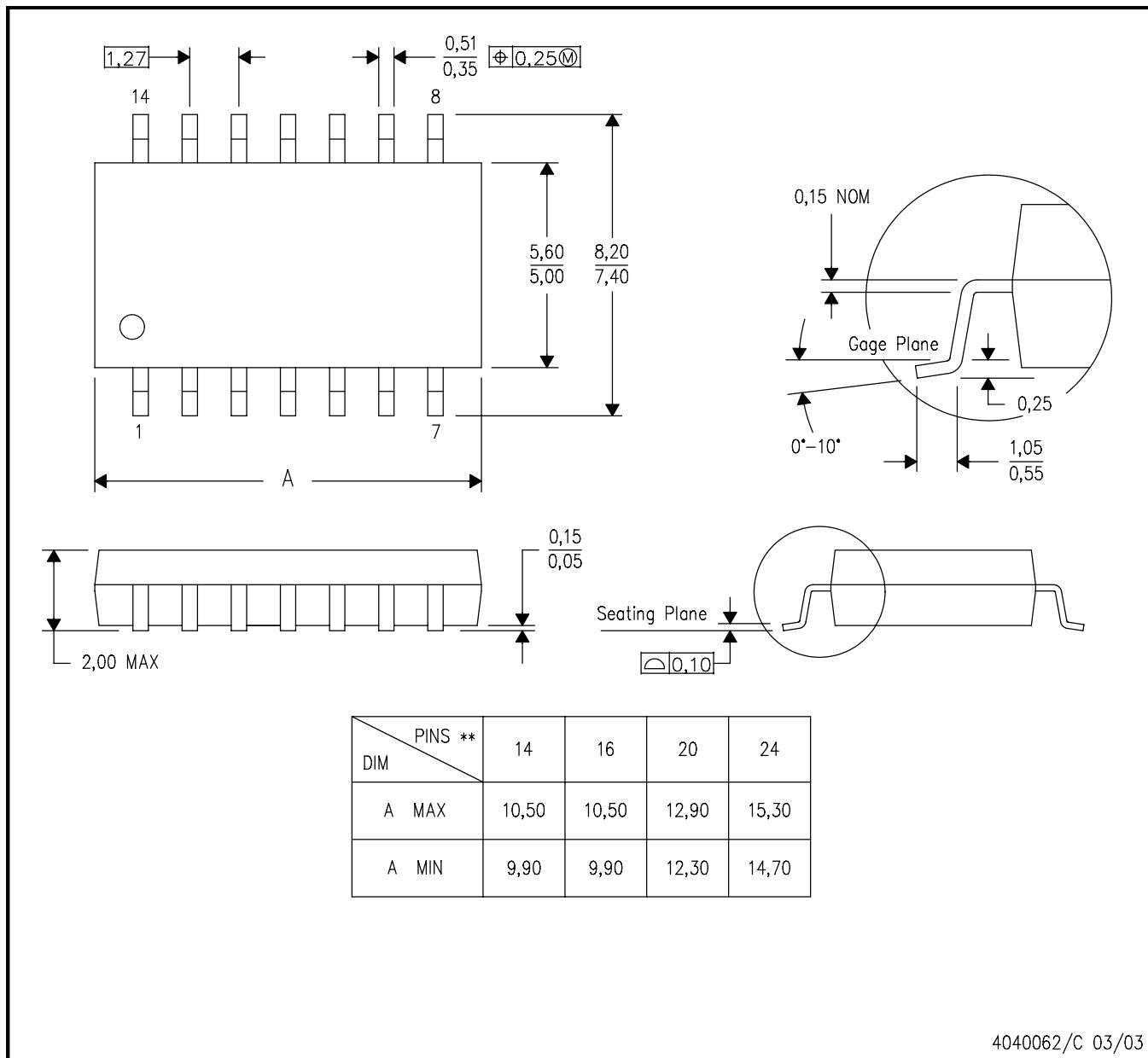
- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0.15).
 D. Falls within JEDEC MS-012

MECHANICAL DATA

NS (R-PDSO-G)**

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE

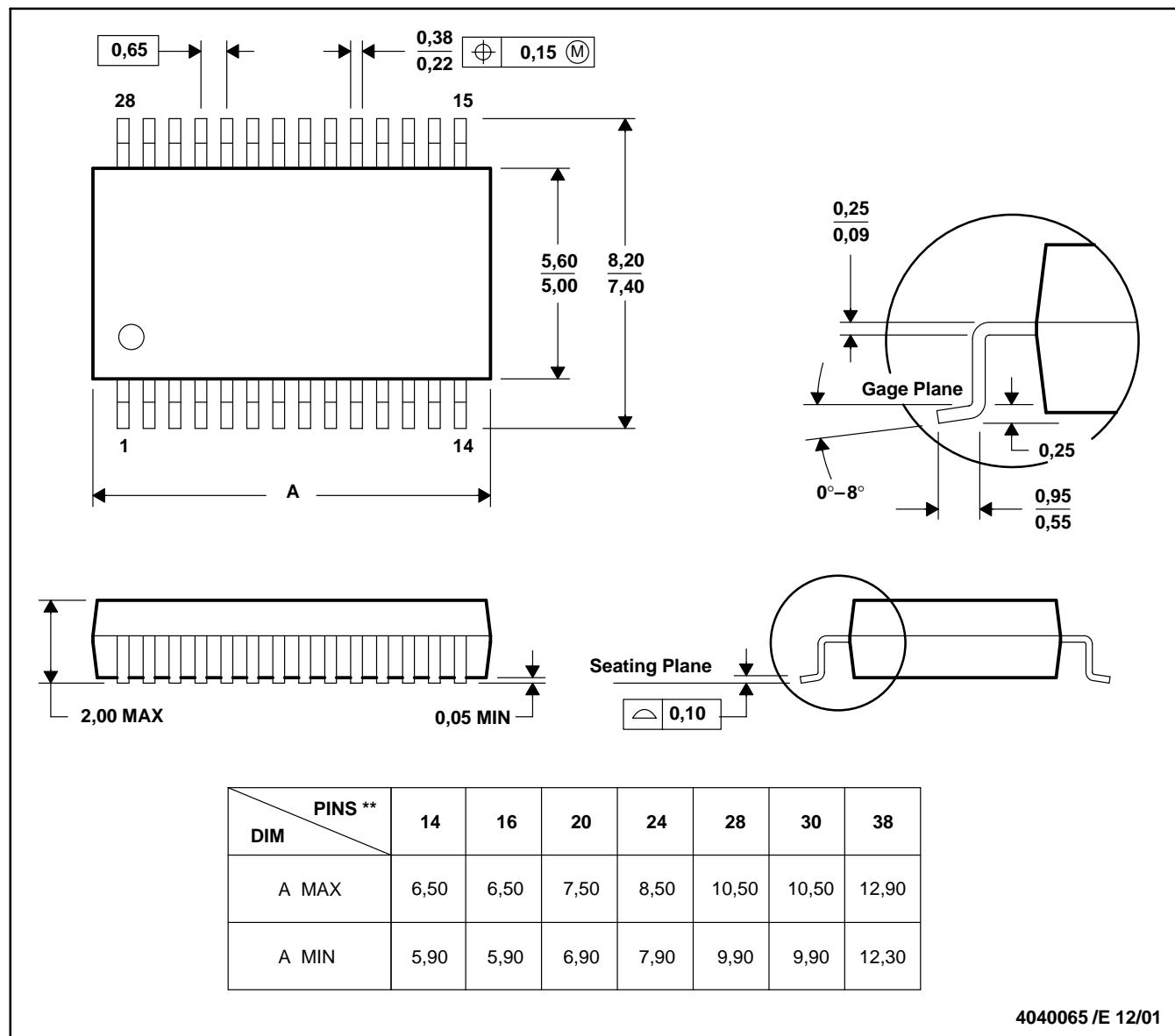


- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN

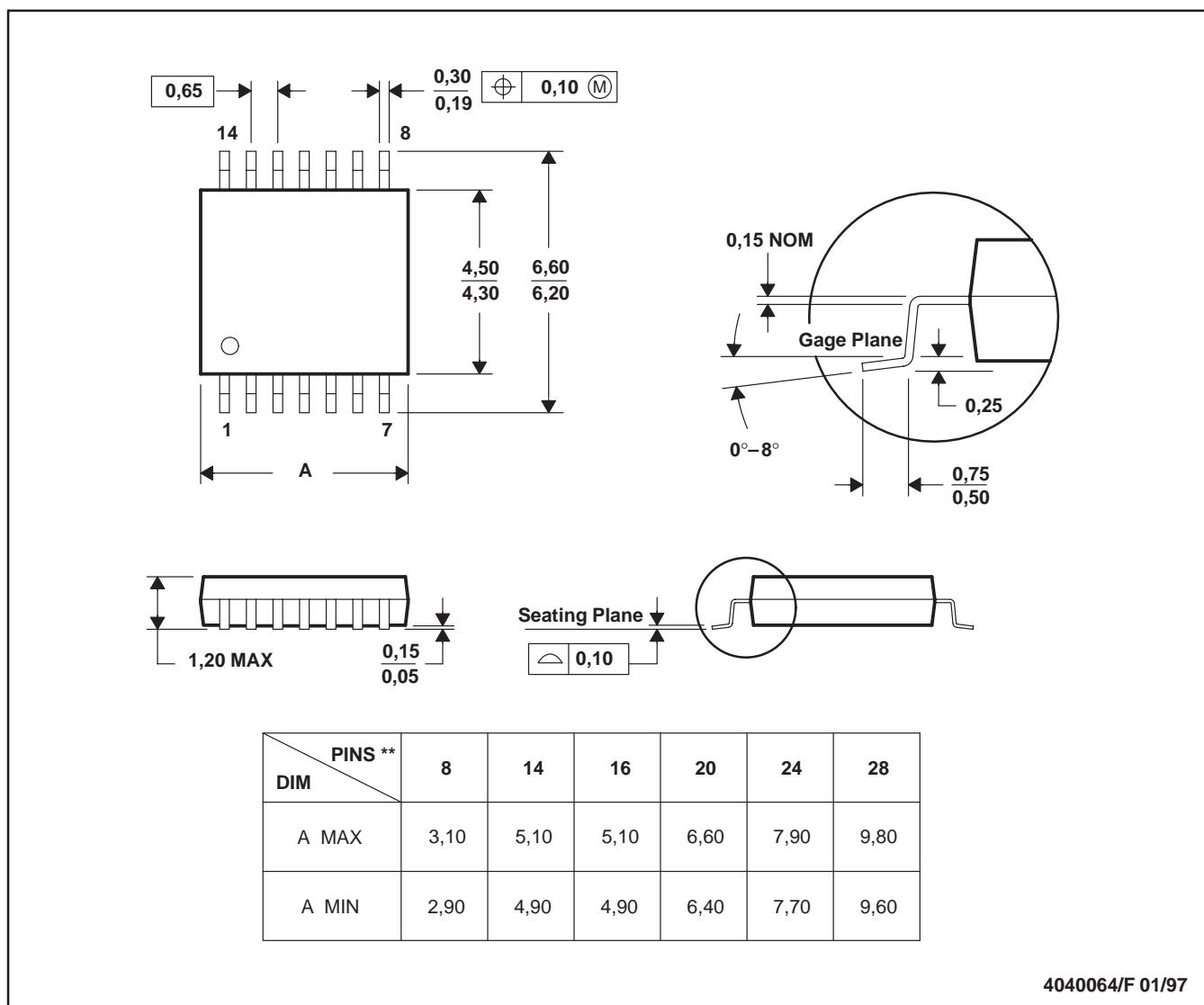


- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 - D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 - Falls within JEDEC MO-153

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Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265

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